



#### Data Sheet

SMT-0727-S-R

#### Features:

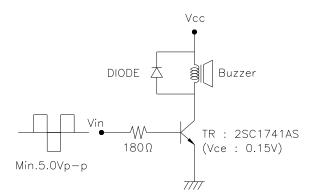
- 7.5x7.5mm SMT magnetic transducer
- 3.6V0-pk, 2.7kHz

#### **Specifications**

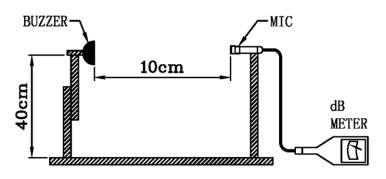
Parameters	Values	Units
Rated Voltage	3.6	V0-pk
Operating Voltage Range	2 ~ 5	V0-pk
Current Draw at Rated Voltage*	120	mA
Coil Resistance	12 ± 2	Ohms
Minimum SPL @ 10cm*	85	dBA
Resonant Frequency	2,700 ± 500	Hz
Housing Material	LCP	-
Terminal Material	Tin-Plated Phosphor Bronze	-
Weight	0.33	Grams
Acceptable Soldering Methods	Hand Solder @ 350C for 5s, Reflow Solder	See page 3 for reflow solder information
Environmental Compliances	RoHS/REACH	-
Moisture Sensitivity Level (MSL)	NA	-
Operating Temperature	-30 ~ +70	°C
Storage Temperature	-40 ~ +85	°C

\*At rated voltage with 50% duty cycle 2.7kHz positive biased square-wave

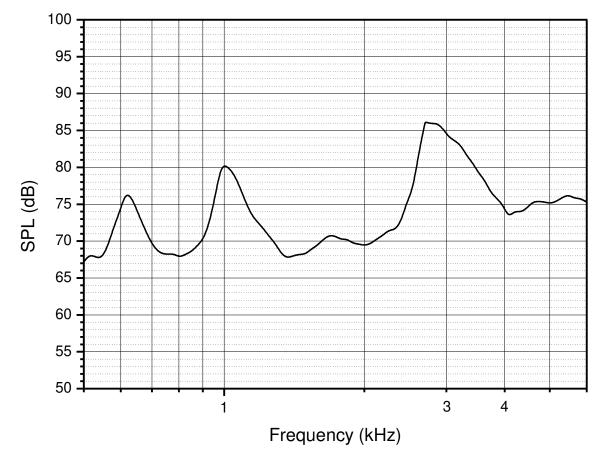
## **Recommended Drive Circuit** (Transistor should have a Vce ≤ 0.15V and hFE ≥ 200)



#### **Test Condition**



# Typical Frequency Response (3.6V0-p input measured at 10cm)

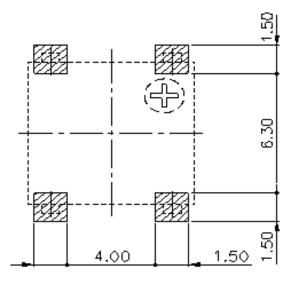


Type of Test	Test Specifications		
High Temperature Test	The part shall be capable of withstanding a temperature +85°C for 96 hours.		
Low Temperature Test	The part shall be capable of withstanding a temperature -40°C for 96 hours		
Humidity Test	Place in chamber with 90-95%RH at 40C for 96 hours followed by ambient room conditions for 2 hours.		
	Total 5 cycles of the following without power.		
	+3		
	+10 +70°C-0 +10 +20°C-5 +20°C-5		
Temperature Cycle Testing	+0		
	-30°C-3 30min 15min 30min 15min		
	1 cycle : 90 min		
	9.3G p-p 1.53mm		
	0.3G		
	10 55Hz		
Vibration Test	Test for direction of X, Y, Z for 2 hours each (6hrs total).		
Drop Test	Drop onto 4cm hardwood board in x,y,z direction (6 times) from 75cm height.		
Solderability	Solder bath temp 300°C ± 5°C, time 3 ± 1 sec		

<b>Reliability</b>	Testing
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After each test, part shall meet specifications with an SPL variance of ±10dB

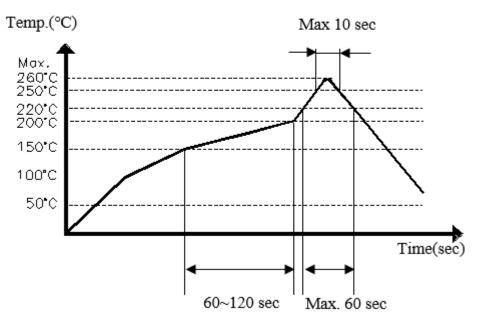
## **Recommended Land Pattern**



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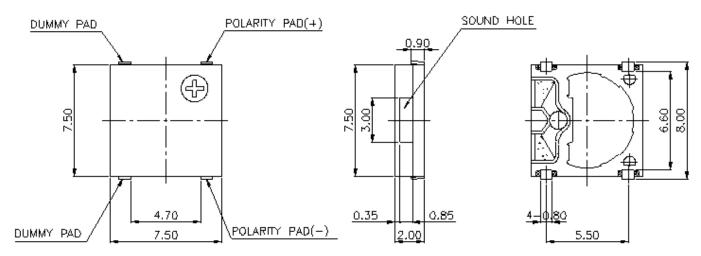
# **Recommended Reflow Soldering Procedure**

- Recommendable reflow soldering condition is as follows.
  - Note 1; It is requested that reflow soldering should be executed after heat of product goes down to normal temperature.
  - Note 2; Peak reflow temperature of 260°C, with a maximum duration of 60 sec. between 220°C and 260°C

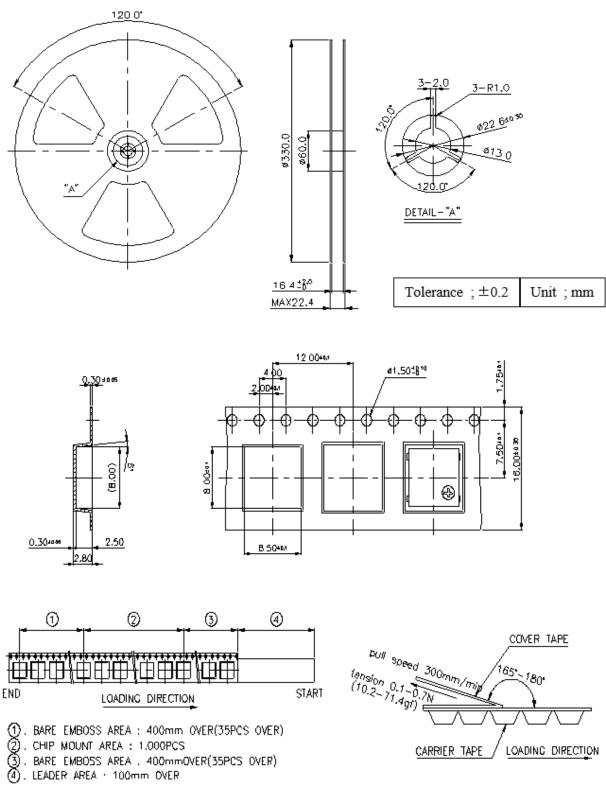


\* Reflow profile of lead-free solder

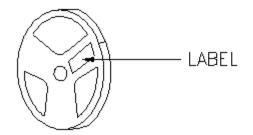
### **Dimensions (Tolerance ±0.2mm)**



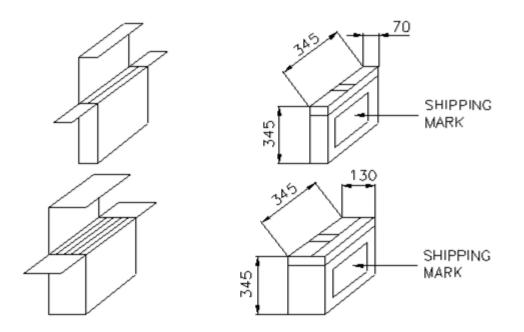
#### Packaging



1,000 PCS per 1roll by using the tapping M/C.



2rolls or 5rolls per 1 double(thick) carton box packed by polypropylene tape.



#### **Specifications Revisions**

Revision	Description	Date
-	Released from Engineering	9/15/2005
А	Revised to 3D Template	4/29/2010
В	Update specification parameters and drawing	12/7/2022

Note:

- 1. Unless otherwise specified:
  - A. All dimensions are in millimeters.
  - B. Default tolerances are  $\pm 0.5$ mm and angles are  $\pm 3^{\circ}$ .
- 2. Specifications subject to change or withdraw without notice.